



60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C (Note 9)
60V	2.8mΩ @ V _{GS} = 10V	100A

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Switching
- Synchronous Rectification
- DC-DC Converters

Mechanical Data

- Case: PowerDI[®] 5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 [®]3
- Weight: 0.097 grams (Approximate)

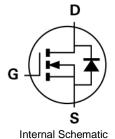
PowerDI5060-8 (Type K)

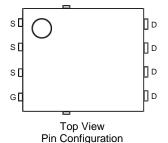






Bottom View





Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH62M8SPS-13	PowerDI5060-8 (Type K)	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



TH62M8SS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 18 = 2018)
WW = Week Code (01 to 53)



Maximum Ratings $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	60	V	
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Notes 6 & 9)	$T_C = +25$ °C	I _D	100	А
Continuous Drain Current, v _{GS} = 10v (Notes 6 & 9)	$T_{C} = +100^{\circ}C$		100	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I_{DM}	400	Α
Continuous Body Diode Forward Current (Note 6)	$T_C = +25$ °C	I _S	100	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I _{SM}	400	Α	
Avalanche Current, L = 0.2mH	I _{AS}	45.5	Α	
Avalanche Energy, L = 0.2mH	E _{AS}	207	mJ	

Thermal Characteristics

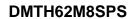
Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	3.2	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	47	°C/W
Total Power Dissipation (Note 6)	P _D	125	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	1.2	°C/W
Operating and Storage Temperature Range	$T_{J,}T_{STG}$	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

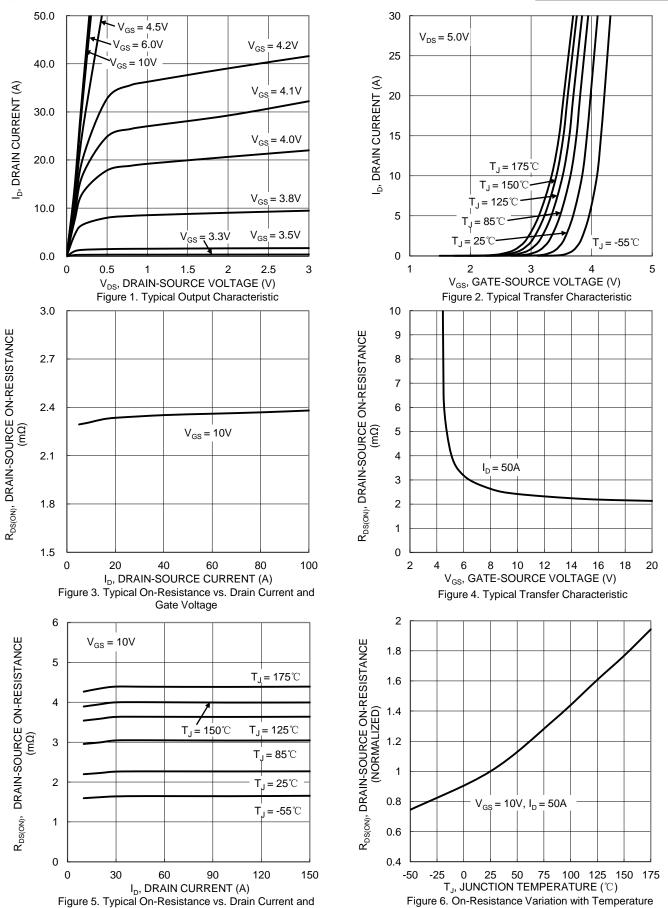
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	2	2.53	4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	ı	2.2	2.8	mΩ	$V_{GS} = 10V, I_D = 50A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	4556	_		$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$	
Output Capacitance	Coss		1383	_	pF		
Reverse Transfer Capacitance	Crss	_	105.2	_			
Gate Resistance	R_{G}	-	0.66	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g	_	95.4	_		$V_{DD} = 30V, I_D = 90A,$ $V_{GS} = 10V$	
Gate-Source Charge	Q_{gs}	_	21.6	_	nC		
Gate-Drain Charge	Q_{gd}	_	20.4	_			
Turn-On Delay Time	t _{D(ON)}	_	13.2	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 90A, R_{G} = 3.5\Omega$	
Turn-On Rise Time	t _R	_	11.7	_			
Turn-Off Delay Time	t _{D(OFF)}	_	31	_	ns		
Turn-Off Fall Time	t _F	_	12	_			
Reverse Recovery Time	t _{RR}	_	50.5	_	ns	I_ FOA di/dt 1004/vo	
Reverse Recovery Charge	Q _{RR}	_	80.8	_	$_{\rm nC}$ I _F = 50A, di/dt = 100A/µs		

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. Notes: 6. Thermal resistance from junction to soldering point (on the exposed drain pad).

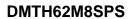
- 7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.9. Limited by package.







Temperature





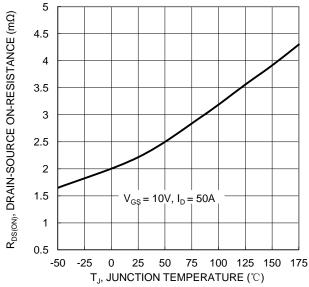


Figure 7. On-Resistance Variation with Temperature

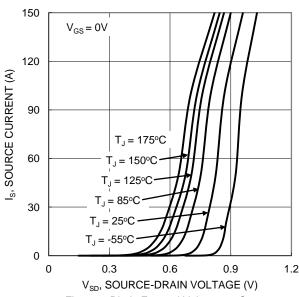


Figure 9. Diode Forward Voltage vs. Current

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V_{DS} = 30V, I_D = 90A

 Q_g (nC) Figure 11. Gate Charge

50 60 70

80

90 100

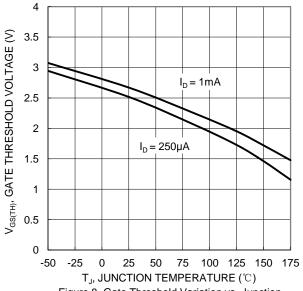
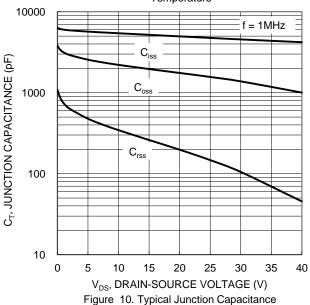


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $P_{DS(ON)}$ 100 $P_{W} = 1 \mu s$ 10 $P_{W} = 10 \mu s$ 10 $P_{W} = 10 \mu s$ 10 $P_{W} = 100 \mu s$ 11 $P_{W} = 100 \mu s$ 12 $P_{W} = 100 \mu s$ 13 $P_{W} = 100 \mu s$ 14 $P_{W} = 100 \mu s$ 15 $P_{W} = 100 \mu s$ 16 $P_{W} = 100 \mu s$ 17 $P_{W} = 100 \mu s$ 18 $P_{W} = 100 \mu s$ 19 $P_{W} = 100 \mu s$ 10 $P_{W} = 10$

 $V_{\rm DS}$, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

0 10 20 30 40



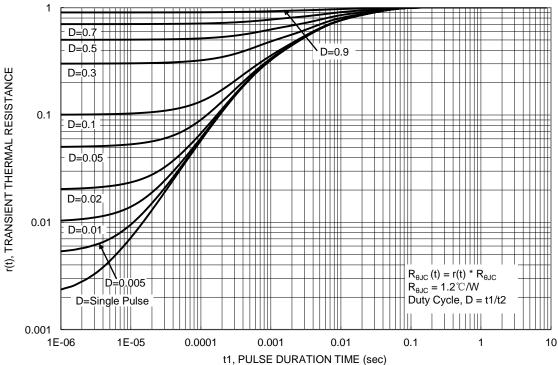


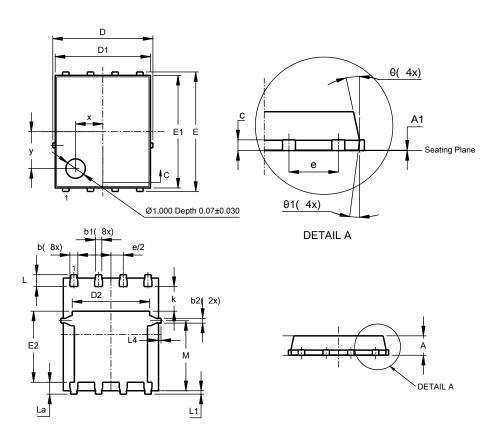
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)

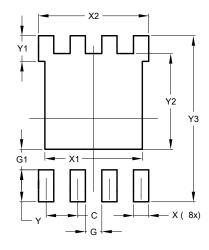


PowerDI5060-8					
(Type K)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05	0.02		
b	0.33	0.51	0.41		
b1	0.300	0.366	0.333		
b2	0.20	0.35	0.25		
С	0.23	0.33	0.277		
D	5	.15 BS0)		
D1	4.85	4.95	4.90		
D2	-	-	3.98		
Е	6	.15 BS	2		
E1	5.75	5.85	5.80		
E2	3.56	3.725	3.66		
е	1	.27BS0)		
k	-	-	1.27		
L	0.51	0.71	0.61		
La	0.51	0.675	0.61		
L1	0.05	0.20	0.175		
L4	-	-	0.125		
М	3.50	3.71	3.605		
X	-	-	1.400		
у	-	-	1.900		
θ	10°	0° 12° 1			
θ1	6° 8°		7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value		
2	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	3.910		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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